

L Number	Hits	Search Text	DB	Time stamp
-	301	solder near cap	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/16 15:02
-	18005	conductive near adhesive	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/16 15:02
-	13	(solder near cap) and (conductive near adhesive)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/16 15:02
-	9	solderable near cap	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/16 15:02